

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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# 2SC460, 2SC461

Silicon NPN Epitaxial Planar

REJ03G0682-0200  
 (Previous ADE-208-1046)  
 Rev.2.00  
 Aug.10.2005

## Application

- 2SC460 high frequency amplifier, mixer
- 2SC461 VHF amplifier, mixer

## Outline

RENESAS Package code: PRSS0003DA-C  
 (Package name: TO-92 (2))



1. Emitter
2. Collector
3. Base

## Absolute Maximum Ratings

(Ta = 25°C)

| Item                         | Symbol    | 2SC460      | 2SC461      | Unit |
|------------------------------|-----------|-------------|-------------|------|
| Collector to base voltage    | $V_{CBO}$ | 30          | 30          | V    |
| Collector to emitter voltage | $V_{CEO}$ | 30          | 30          | V    |
| Emitter to base voltage      | $V_{EBO}$ | 5           | 5           | V    |
| Collector current            | $I_C$     | 100         | 100         | mA   |
| Collector power dissipation  | $P_C$     | 200         | 200         | mW   |
| Junction temperature         | $T_j$     | 150         | 150         | °C   |
| Storage temperature          | $T_{stg}$ | -55 to +150 | -55 to +150 | °C   |

**Electrical Characteristics**

(Ta = 25°C)

| Item                                    | Symbol        | 2SC460 |      |      | 2SC461 |      |      | Unit    | Test conditions   |
|---|---------------|--------|------|------|--------|------|------|---------|---|
|   |               | Min    | Typ  | Max  | Min    | Typ  | Max  |         |   |
| Collector to base breakdown voltage     | $V_{(BR)CBO}$ | 30     | —    | —    | 30     | —    | —    | V       | $I_C = 10 \mu A, I_E = 0$   |
| Collector to emitter breakdown voltage  | $V_{(BR)CEO}$ | 30     | —    | —    | 30     | —    | —    | V       | $I_C = 1 \text{ mA}, R_{BE} = \infty$   |
| Emitter to base breakdown voltage       | $V_{(BR)EBO}$ | 5      | —    | —    | 5      | —    | —    | V       | $I_E = 10 \mu A, I_C = 0$   |
| Collector cutoff current                | $I_{CBO}$     | —      | —    | 0.5  | —      | —    | 0.5  | $\mu A$ | $V_{CB} = 18 \text{ V}, I_E = 0$  |
| Emitter cutoff current                  | $I_{EBO}$     | —      | —    | 0.5  | —      | —    | 0.5  | $\mu A$ | $V_{EB} = 2 \text{ V}, I_C = 0$   |
| Base to emitter voltage                 | $V_{BE}$      | —      | 0.63 | 0.75 | —      | 0.63 | 0.75 | V       | $V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$   |
| DC current transfer ratio               | $h_{FE}^{*1}$ | 100    | —    | 200  | 35     | —    | 200  |         | $V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$   |
| Collector to emitter saturation voltage | $V_{CE(sat)}$ | —      | 0.6  | 1.1  | —      | 0.6  | 1.1  | V       | $I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$   |
| Gain bandwidth product                  | $f_T$         | —      | 230  | —    | —      | 230  | —    | MHz     | $V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$   |
| Collector output capacitance            | $C_{ob}$      | —      | 1.8  | 3.5  | —      | 1.8  | 3.5  | pF      | $V_{CB} = 10 \text{ V}, I_E = 0,$<br>$f = 1 \text{ MHz}$                                |
| 10.7 MHz power gain                     | PG            | 26     | 29   | —    | —      | —    | —    | dB      | $V_{CE} = 6 \text{ V}, I_E = -1 \text{ mA}$<br>$f = 10.7 \text{ MHz}$                   |
| 100 MHz power gain                      | PG            | —      | —    | —    | 13     | 17   | —    | dB      | $V_{CE} = 6 \text{ V}, I_E = -1 \text{ mA}$<br>$f = 100 \text{ MHz}$                    |
| Noise figure                            | NF            | —      | 2.0  | —    | —      | —    | —    | dB      | $V_{CE} = 6 \text{ V}, I_E = -1 \text{ mA}$<br>$f = 1 \text{ MHz}$<br>$R_g = 500\Omega$ |

Note: 1. The 2SC461 is grouped by  $h_{FE}$  as follows.

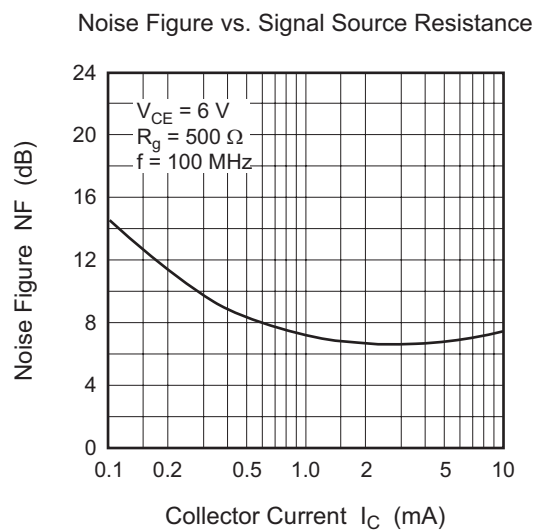
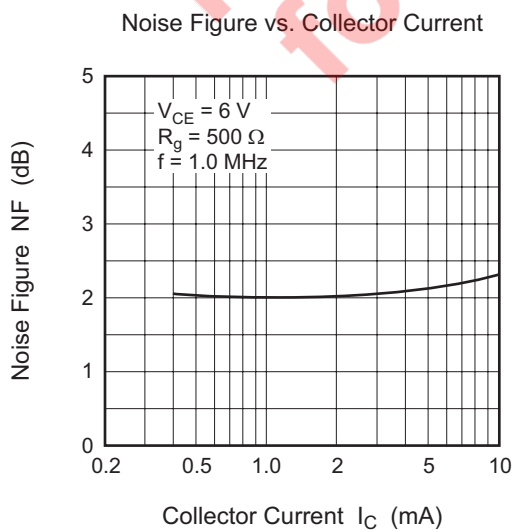
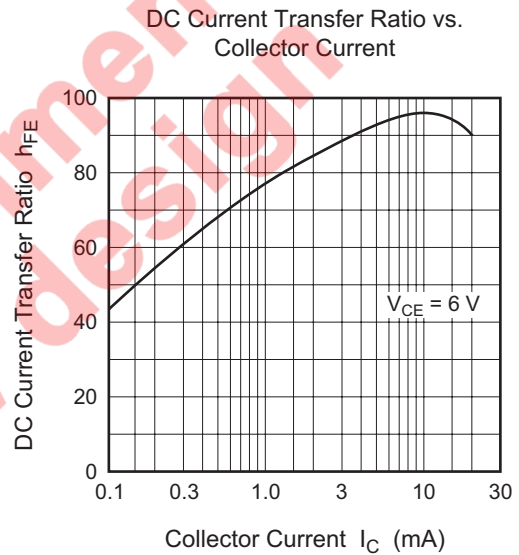
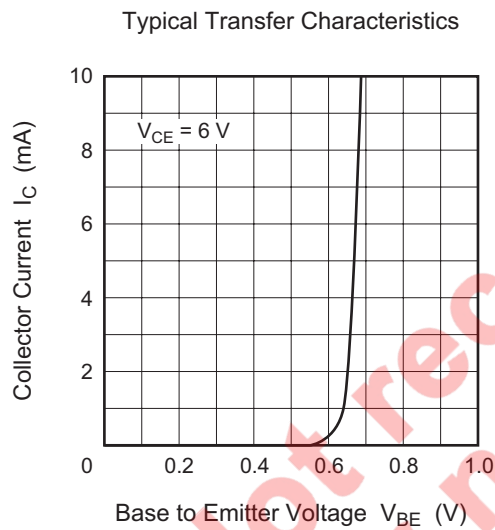
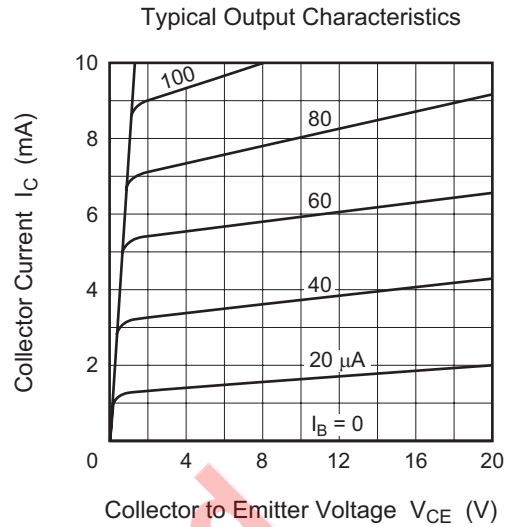
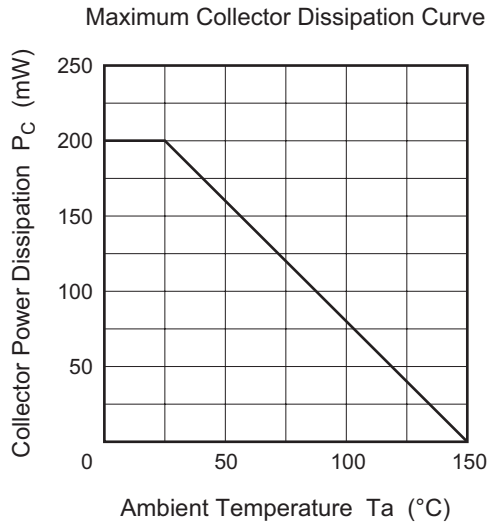
| B         | C          |
|-----------|------------|
| 60 to 120 | 100 to 200 |

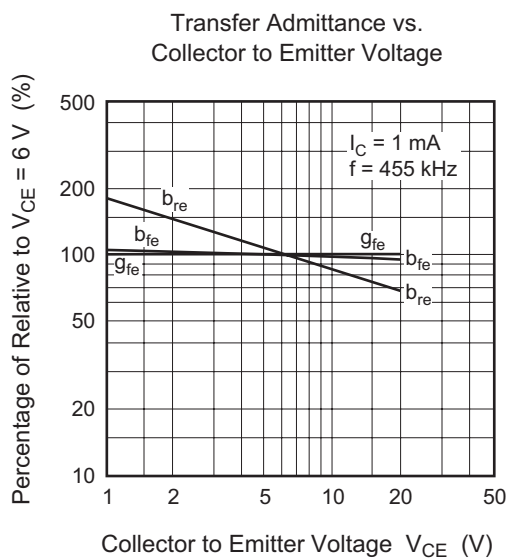
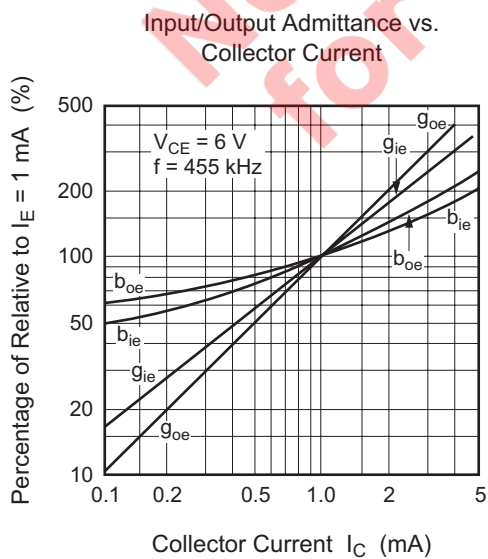
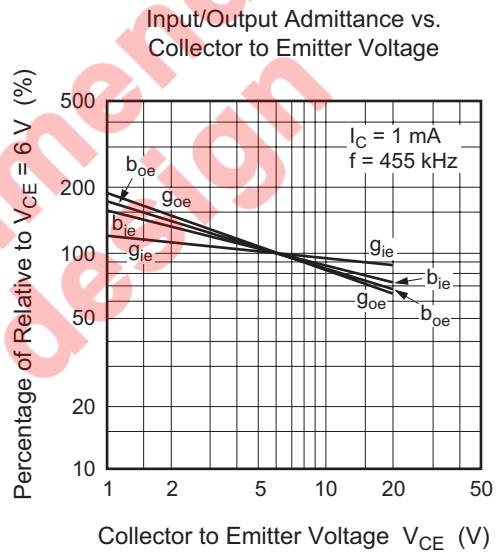
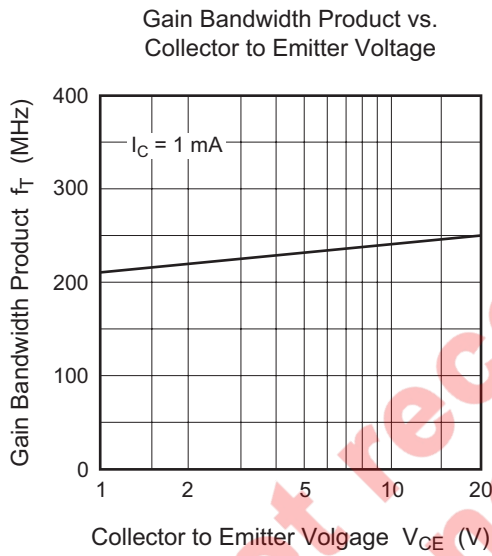
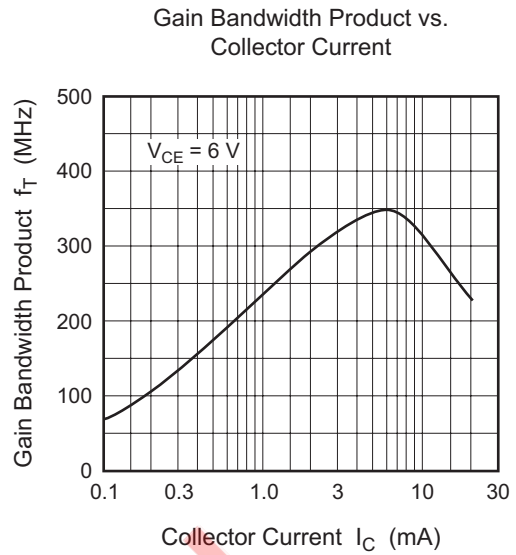
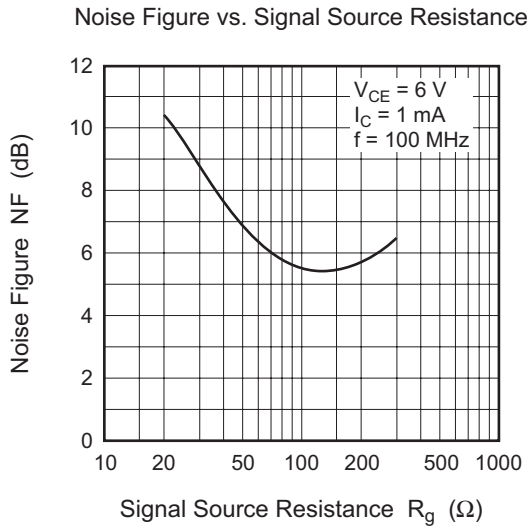
**Small Signal y Parameters**

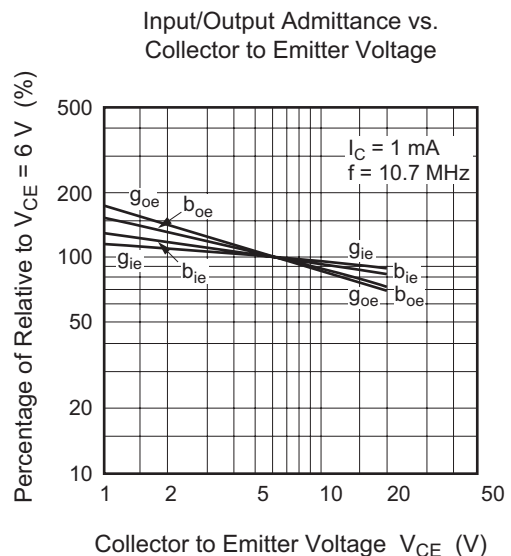
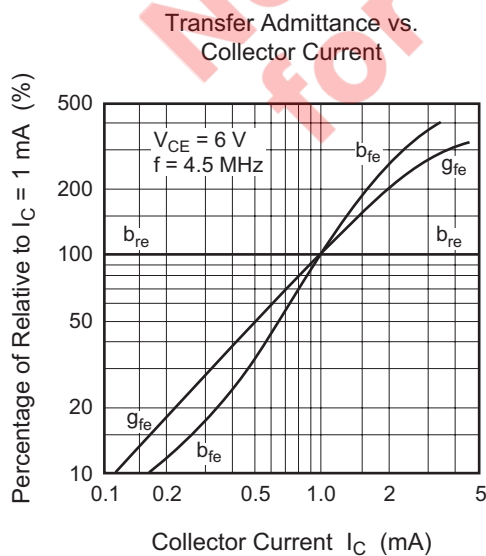
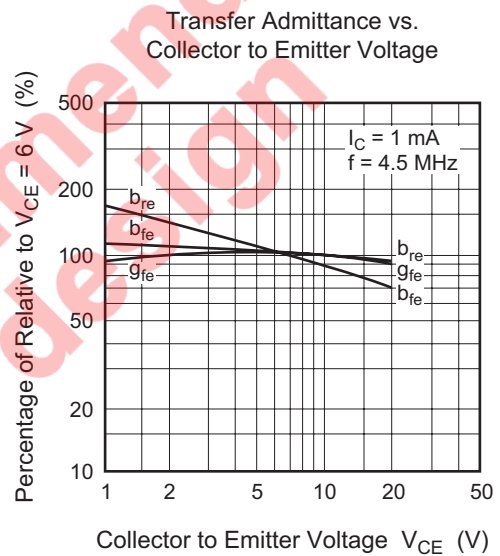
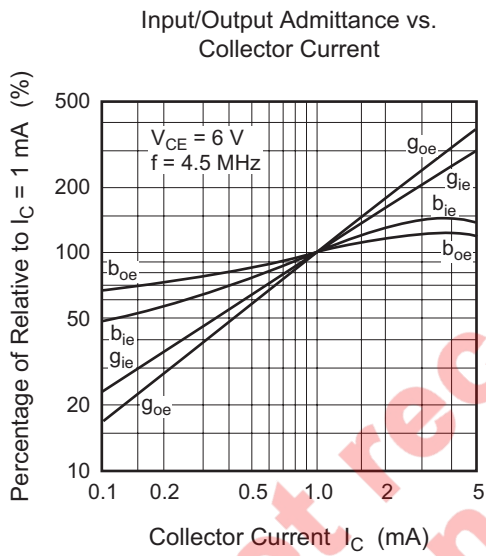
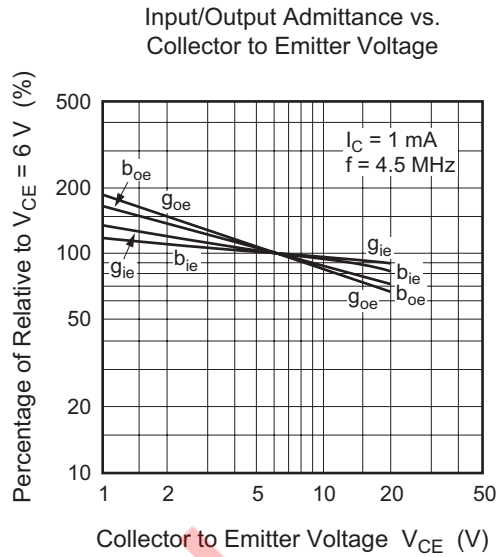
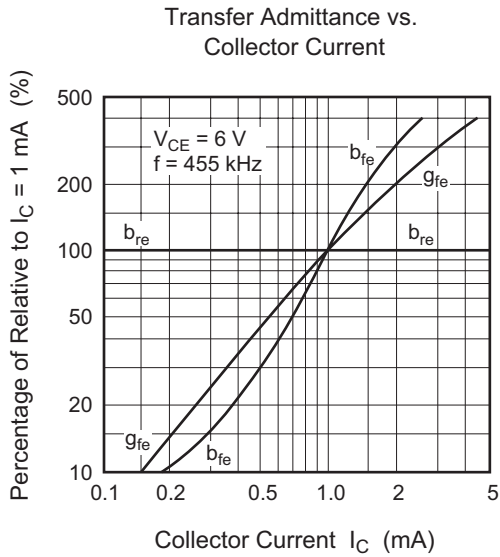
( $V_{CE} = 6 \text{ V}, I_C = 1 \text{ mA}, \text{Emitter Common}$ )

| Item                        | Symbol | f        | 2SC460A,<br>2S461A | 2SC460B,<br>2SC461B | 2SC460C,<br>2SC461C | Unit |
|-----------------------------|--------|----------|--------------------|---------------------|---------------------|------|
| Input admittance            | yie    | 455 kHz  | $0.58 + j0.074$    | $0.42 + j0.068$     | $0.30 + j0.051$     | mS   |
|                             |        | 4.5 MHz  | $0.65 + j0.79$     | $0.50 + j0.7$       | $0.35 + j0.57$      |      |
|                             |        | 10.7 MHz | $0.91 + j2.0$      | $0.61 + j1.9$       | $0.39 + j1.3$       |      |
|                             |        | 100 MHz  | $7.4 + j14$        | $5.6 + j12$         | $3.8 + j6.0$        |      |
| Reverse transfer admittance | yre    | 455 kHz  | $-j0.003$          | $-j0.003$           | $-j0.003$           | mS   |
|                             |        | 4.5 MHz  | $-j0.04$           | $-j0.04$            | $-j0.04$            |      |
|                             |        | 10.7 MHz | $-j0.13$           | $-j0.13$            | $-j0.13$            |      |
|                             |        | 100 MHz  | $-j1.0$            | $-j1.0$             | $-j1.0$             |      |
| Forward transfer admittance | yfe    | 455 kHz  | $38 - j0.1$        | $37 - j0.1$         | $37 - j0.2$         | mS   |
|                             |        | 4.5 MHz  | $35 - j1.0$        | $35 - j1.2$         | $34 - j1.8$         |      |
|                             |        | 10.7 MHz | $34 - j2.5$        | $34 - j2.5$         | $33 - j4.5$         |      |
|                             |        | 100 MHz  | $28 - j20$         | $28 - j19$          | $20 - j19$          |      |
| Output admittance           | yoe    | 455 kHz  | $0.0098 + j0.009$  | $0.013 + j0.009$    | $0.016 + j0.012$    | mS   |
|                             |        | 4.5 MHz  | $0.02 + j0.09$     | $0.023 + j0.092$    | $0.03 + j0.10$      |      |
|                             |        | 10.7 MHz | $0.11 + j0.4$      | $0.11 + j0.4$       | $0.12 + j0.4$       |      |
|                             |        | 100 MHz  | $0.40 + j1.7$      | $0.50 + j2.0$       | $0.83 + j2.0$       |      |

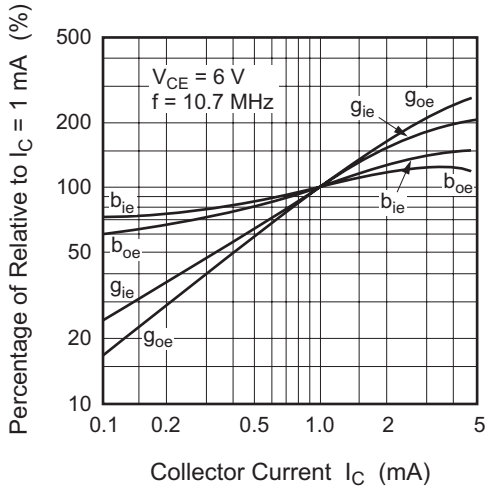
Main Characteristics



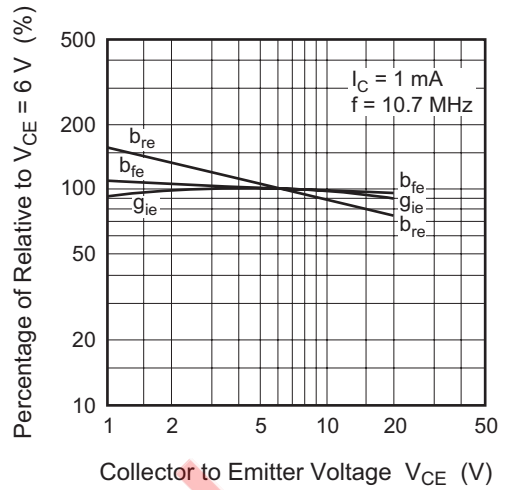




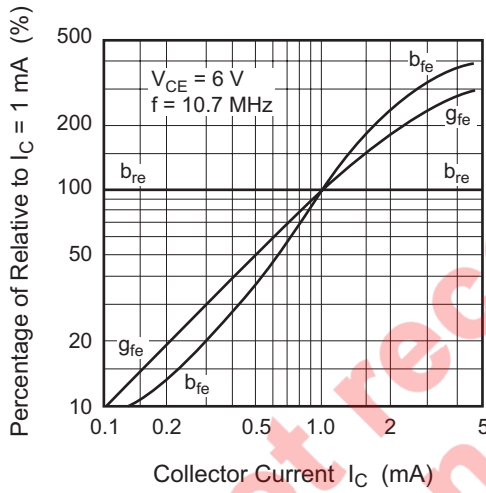
Input/Output Admittance vs. Collector Current



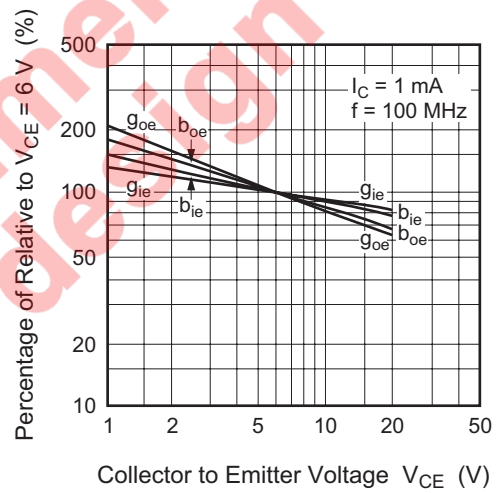
Transfer Admittance vs. Collector to Emitter Voltage



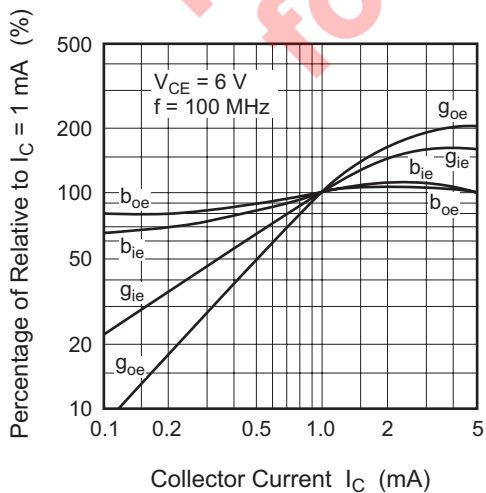
Transfer Admittance vs. Collector Current



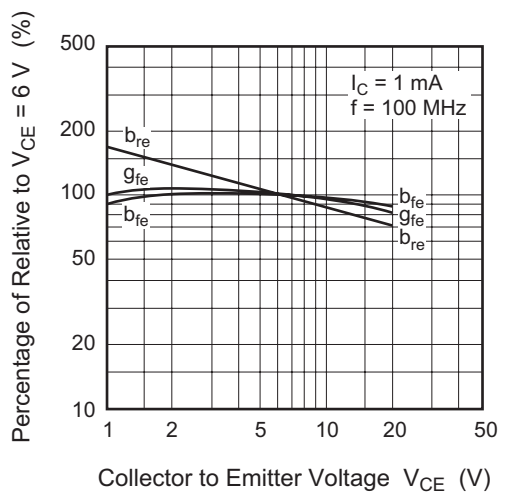
Input/Output Admittance vs. Collector to Emitter Voltage



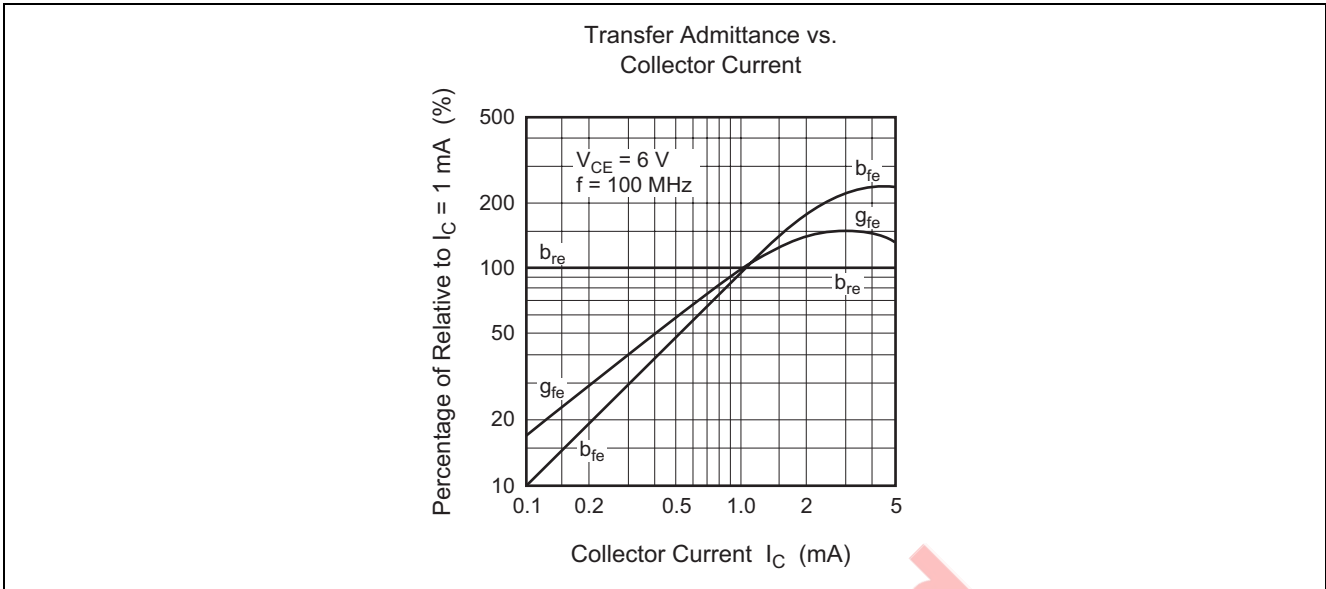
Input/Output Admittance vs. Collector Current



Transfer Admittance vs. Collector to Emitter Voltage

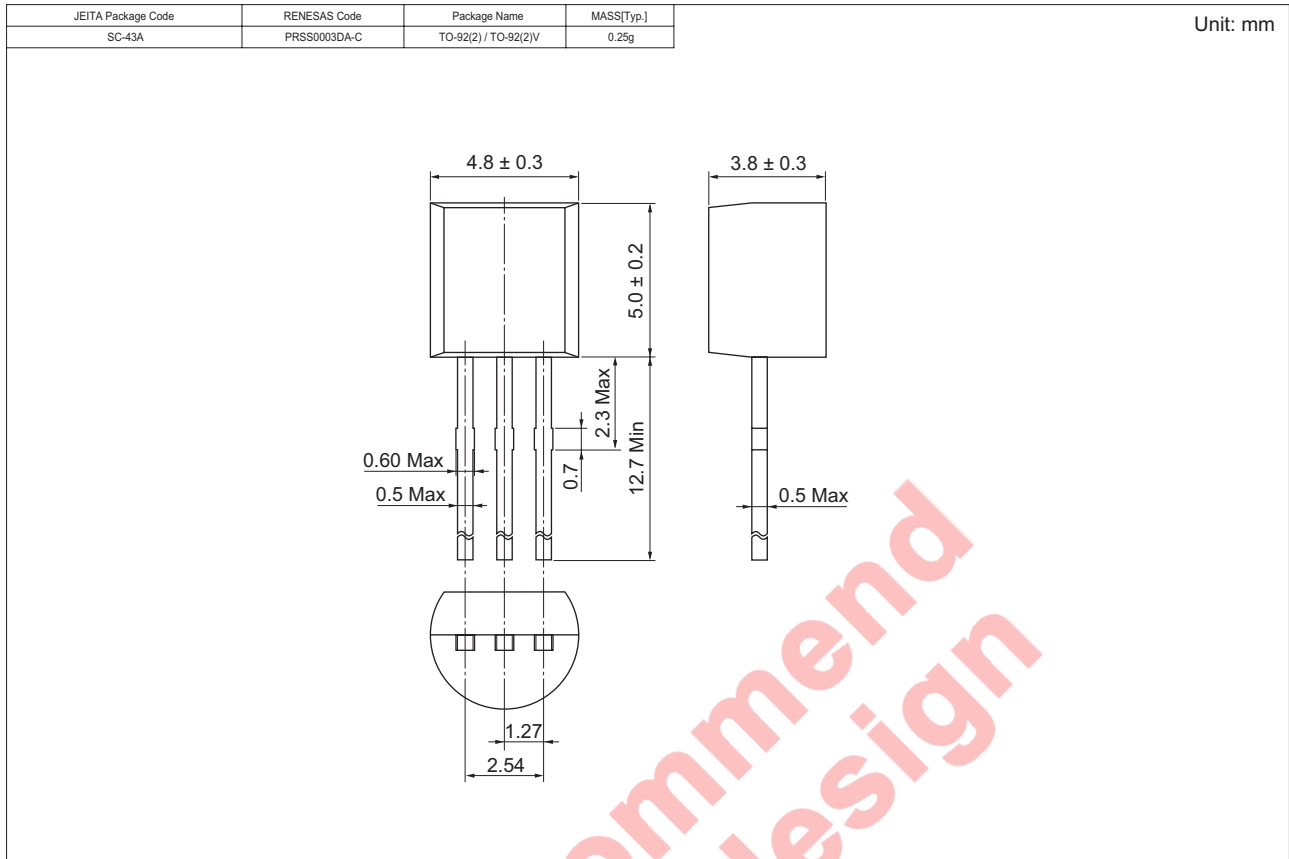






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## Package Dimensions



## Ordering Information

| Part Name                           | Quantity | Shipping Container      |
|-------------------------------------|----------|-------------------------|
| 2SC460CTZ<br>2SC461BTZ<br>2SC461CTZ | 2500     | Hold Box, Radial Taping |

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